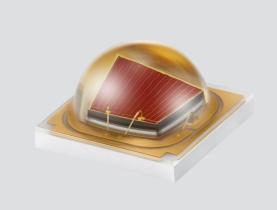
High Power LED Series 3535 Ceramic

LH351H Red



Features & Benefits

Package : 2pad design package with Al2O3

• Dimension: 3.5 mm X 3.5 mm

Technology : AlGaInP

Operates at a maximum current of up to 1.0 A







Applications

Horticulture

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1. Characteristics

a) Absolute Maximum Rating

ltem	Symbol	Rating	Unit	Condition
Ambient / Operating Temperature	Ta	-40 ~ +105	°C	Note 1)*
Storage Temperature	T_{stg}	-40 ~ +105	°C	-
LED Junction Temperature	T _j	125	°C	-
Forward Current (T _j : 25 °C)	l _F	1000	mA	Note 2,3)*-
Reverse Voltage ((@ 10 mA)	V _r	1.1	V	-
Assembly Process Temperature		260 <10	°C	-
ESD (HBM)	-	±8	kV	-

Notes:

- 1) Refer to the derating curve, '3. Typical Characteristics Graph', for proper driving current that maintained below maximum junction temperature.
- 2) Unpredictable performance may be resulted by driving the product at above Max. IF. But there will be no damage to the product.
- 3) The measurement condition means that temperature is excluded by applying pulse current for under 30ms.

b) Electro-optical Characteristics

ltem	Unit	Cond	ition	Value
item	Offic	I _F (mA)	T _j (°C)	Тур.
Radiant Power (Φ_E)	mW	350	25	350
Forward Voltage (V _F)	V	350	25	1.9
Thermal Resistance (junction to solder point)	°C/W	350	25	3.9
Beam Angle	0	350	25	120
Peak wavelength (λ_p)	nm	350	25	730
Plant Biologically-Active Photon Flux	μ mol/s	350	25	2.07

Notes:

- 1) Samsung maintains measurement tolerance of: Radiant Power = ± 7 %, forward voltage = ± 0.1 V, Dominant Wavelength = ± 2 nm
- 2) Characteristics @ 25 $^{\circ}\text{C}$ are for reference only

2. Product Code Information

1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18
S	Р	н	R	D	2		3	D	н	0	1	Δ	8	4	4	B	0

Digit	PKG Information	Code	Specification
1 2 3	Samsung Package High Power	SPH	
4 5	Color	RD	Red
6	Product Version	2	
7 8	Product	L3	LH351 Series
9	Lens Type	D	Dome lens
10	Internal Code	Н	
11	Not Defined	0	Default
12	Red Version	1	730nm
13 14	Forward Voltage (V)	A8	1.6 ~ 2.4
15 16	Wavelength (nm)	44	720 ~ 740
17 18	Radiant Power (mW)	В0	310 ~

a) Voltage Bins (I_F = 350 mA, T_j = 25 °C)

Product Code	Voltage Rank	Voltage Bin	Voltage Range (V)
SPHRD2L3DH01 A84 4B0	A8	A8	1.6 ~ 2.4

b) Wavelength Bins ($I_F = 350 \text{ mA}, T_j = 25 \text{ }^{\circ}\text{C}$)

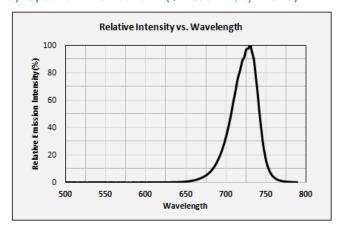
Product Code	Wavelength Rank	Wavelength Bin	Wavelength Range (nm)
SPHRD2L3DH01A8 44 B0	44	44	720 ~ 740

c) Radiant Power Bins ($I_F = 350 \text{ mA}, T_j = 25 \text{ }^{\circ}\text{C}$)

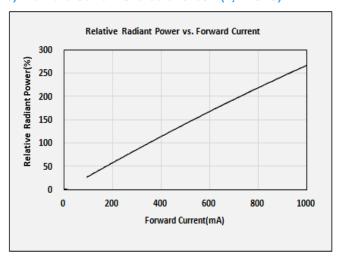
Product Code	Power Rank	Power Bin	Power Range (mW)
SPHRD2L3DH01A844 B0	В0	В0	310 ~

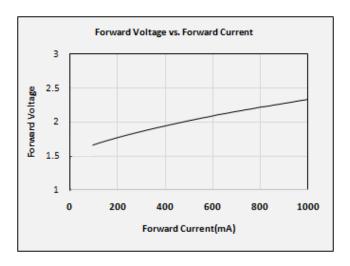
3. Typical Characteristics Graphs

a) Spectrum Distribution ($I_F = 350 \text{ mA}, T_j = 25 \text{ }^{\circ}\text{C}$)



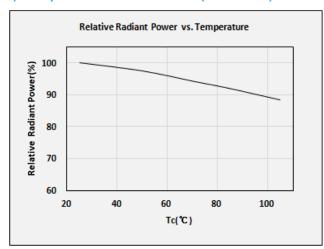
b) Forward Current Characteristics $(T_j = 25 \text{ }^{\circ}\text{C})$

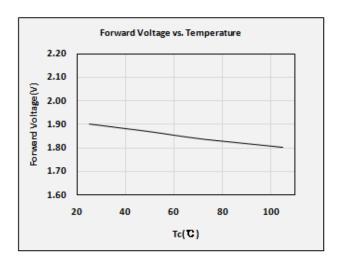




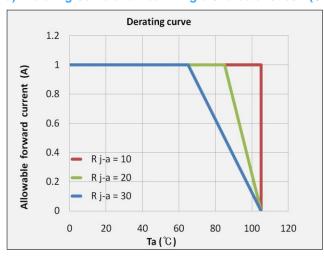
3. Typical Characteristics Graphs

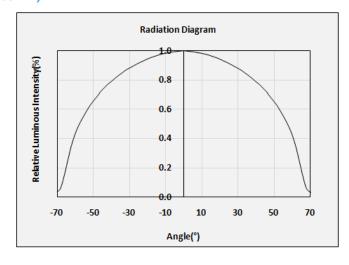
c) Temperature Characteristics (I_F = 350 mA)



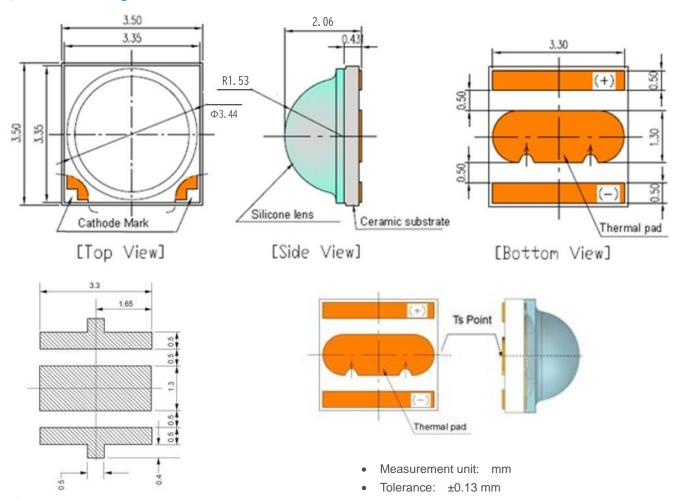


d) Derating Curve and Beam Angle Characteristics (I_F = 350 mA)





4. Outline Drawing & Dimension



Recommended Soldering Pattern

Notes:

- 1) This LED has built-in ESD protection device(s) connected in parallel to LED chip(s).
- 2) The thermal pad is electrically isolated from the anode and cathode contact pads.
- 3) T_s point and measurement method:
 - 1) Measure the nearest point to thermal pad as shown above. If necessary, remove PSR of PCB to reach T_s point.
 - 2 All pads must be soldered to the PCB to dissipate heat properly, otherwise the LED can be damaged.

Precautions:

- 1) Pressure on the LEDs will influence to the reliability of the LEDs. Precautions should be taken to avoid strong pressure on the LEDs. Do not put stress on the LEDs during heating.
- 2) Re-soldering should not be done after the LEDs have been soldered. If re-soldering is unavoidable, LED's characteristics should be carefully checked before and after such repair.
- 3) Do not stack assembled PCBs together. Since materials of LEDs is soft, abrasion between two PCB assembled with LED might cause catastrophic failure of the LEDs.

5. Reliability Test Items & Conditions

a) Test Items

Test Item	Test Condition		Test Hour / Cycle	Sample Size
High Temperature Life Test	85 °C, Maximum Rated Drive Curi	rent	1000 h	22
High Temperature Humidity Life Test	85 °C, 85 % RH, Maximum Rated Drive	e Current	1000 h	22
Low Temperature Life Test	-40 °C, Maximum Rated Drive Cur	rent	1000 h	22
Temperature Cycling	-45 °C / 15 min ↔ 125 °C / 15 m temperature change within 5 mi		500 cycles	100
High Temperature Storage	120 ℃		1000 h	11
High Temperature Humidity Storage	85 °C, 85 %		1000 h	11
ESD (HBM)	R ₁ R ₂ R ₂ : 1	10 MΩ 1.5 kΩ 00 pF ±8 kV	5 times	30
ESD (MM)	R ₂ : 0	10 MΩ) 00 pF ±0.5 kV	5 times	30

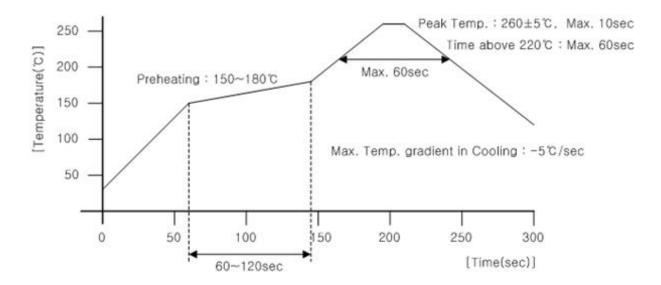
b) Criteria for Judging the Damage

ltem	Symbol	Test Condition	Lir	nit
item	Зуппон	(T _j = 25 °C)	Min.	Max.
Forward Voltage	V_{F}	$I_F = 350 \text{ mA}$	Init. Value * 0.9	Init. Value * 1.1
Luminous Flux	Φν	I _F = 350 mA	Init. Value * 0.7	Init. Value * 1.1

6. Soldering Conditions

a) Reflow Conditions (Pb free)

Reflow frequency: 2 times max.



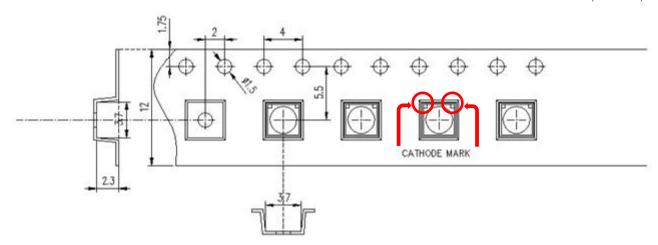
b) Manual Soldering Conditions

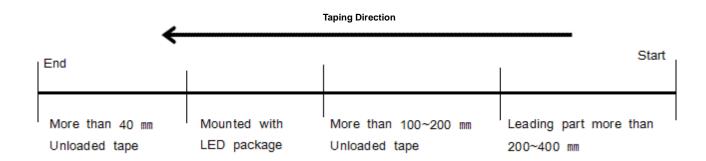
Not more than 5 seconds @ max. 300 °C, under soldering iron.

7. Tape & Reel

a) Taping Dimension

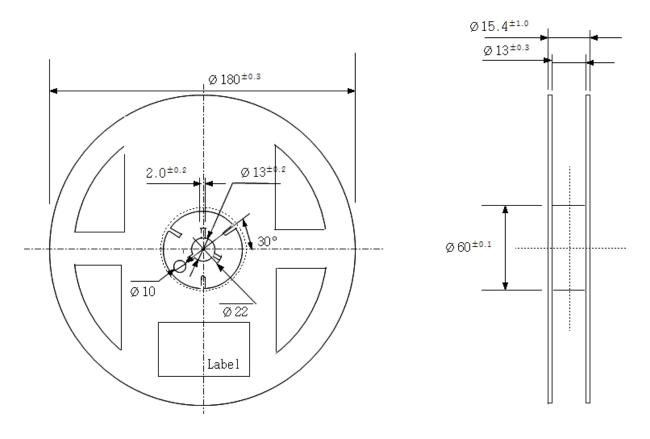
(unit: mm)





b) Reel Dimension

(unit: mm)

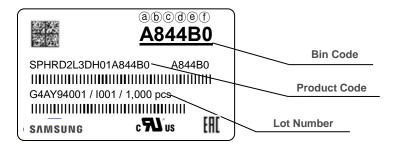


Notes:

- 1) Quantity: The quantity/reel is 1,000 pcs
- 2) Cumulative tolerance: Cumulative tolerance / 10 pitches is ±0.2 mm
- 3) Adhesion strength of cover tape: Adhesion strength is 0.1-0.7 N when the cover tape is turned off from the carrier tape at 10° angle to the carrier tape
- 4) Packaging: P/N, Manufacturing data code no. and quantity are indicated on the aluminum packing bag

8. Label Structure

a) Label Structure



Note: Denoted bin code and product code above is only an example (see description on page 4)

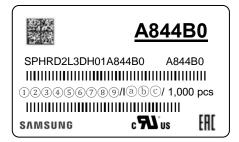
Bin Code:

(a) (refer to page 5)

©d: Wavelength bin (refer to page 5)

b) Lot Number

The lot number is composed of the following characters:



123456789/Iabc /1,000 pcs

①, ② : Production site (G4 : Guangzhou, China)

3 : Product state (A: Normal, B: Bulk, C: First Production, R: Reproduction, S: Sample)

(C: 2018, D: 2019, E: 2020, ...)

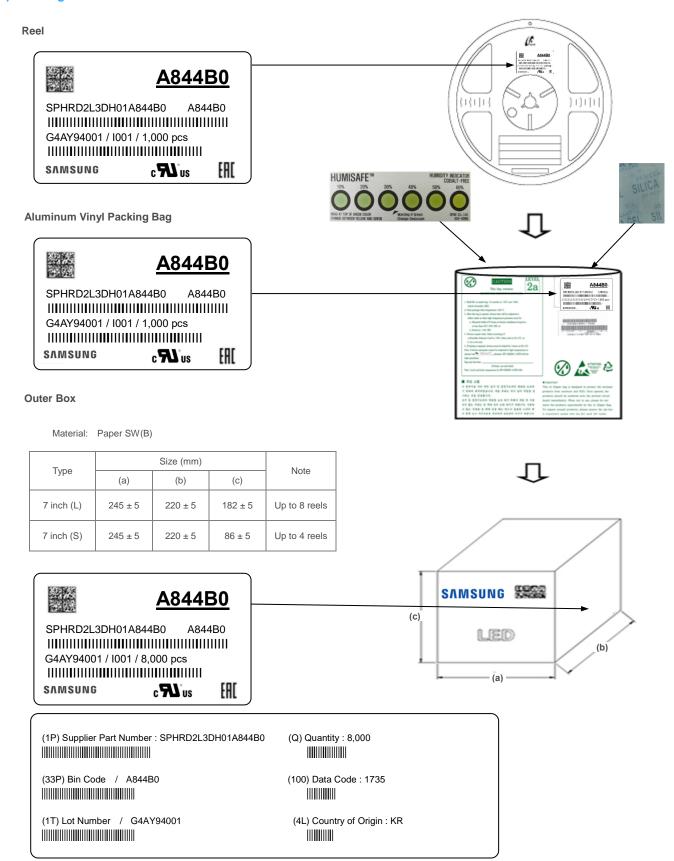
(5) : Month (1~9, A, B, C)
(6) : Day (1~9, A, B~V)

(7) 8 9 : Product serial number (001 ~ 999)

(a)b)c : Reel number (001 ~ 999)

9. Packing Structure

a) Packing Process



b) Aluminum Vinyl Packing Bag



CAUTION

LEVEL

This bag contains MOISTURE SENSITIVE DEVICES

- 1. Shelf life in sealed bag: 12 months at < 40°C and < 90% relative humidity (RH)
- 2. Peak package body temperature: 240 °C
- 3. After this bag is opened, devices that will be subjected to reflow solder or other high temperature processes must be:
 - a. Mounted within 672 hours at factory conditions of equal to or less than 30°C /60% RH, or
 - b. Stored at < 10% RH
- 4. Devices require bake, before mounting, if: a. Humidity Indicator Card is > 65% when read at 23 ±5°C, or b. 2a is not met.
- 5. If baking is required, devices must be baked for 1 hours at 60 ± 5 °C Note: if device containers cannot be subjected to high temperature or shorter bake times are desired, reference IPC/JEDEC J-STD-033 for bake procedure.

Bag seal due date: _

(if blank, see code label)

Note: Level and body temperature by IPC/JEDEC J-STD-020









■ 주의 사항

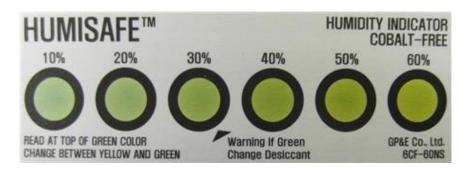
이 알루미늄 지퍼 백은 습기 및 정전기로부터 제품을 보호하 기 위하여 제작되었습니다. 개봉 후에는 즉시 솔더 작업을 실 시하는 것을 권장합니다.

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products from moisture and ESD. Once opened, the products should be soldered onto the printed circuit board immediately. When not in use, please do not leave the products unprotected by the Al Zipper Bag. To repack unused products, please ensure the zip-lock is completely sealed with the dry pack left inside.

c) Silica Gel & Humidity Indicator Card inside Aluminum Vinyl Bag







A844B0

SPHRD2L3DH01A844B0 G4AY94001 / I001 / 1,000 pcs

SAMSUNG

c**Al**us

EHC



■ Important

This Al Zipper bag is designed to protect the enclosed

10. Precautions in Handling & Use

- For over-current protection, users are recommended to apply resistors connected in series with the LEDs to mitigate sudden change of the forward current caused by shift of forward voltage.
- 2) This device should not be used in any type of fluid such as water, oil, organic solvent, etc. When cleaning is required, IPA is recommended as the cleaning agent. Some solvent-based cleaning agent may damage the silicone resins used in the device.
- 3) When the device is in operation, the forward current should be carefully determined considering the maximum ambient temperature and corresponding junction temperature.
- 4) LEDs must be stored in a clean environment. If the LEDs are to be stored for three months or more after being shipped from Samsung, they should be packed with a nitrogen-filled container (shelf life of sealed bags is 12 months at temperature 0~40 °C, 0~90 % RH).
- 5) After storage bag is opened, device subjected to soldering, solder reflow, or other high temperature processes must be:
 - a. Mounted within 672 hours (28 days) at an assembly line with a condition of no more than 30 °C / 60 % RH, or
 - b. Stored at <10 % RH
- 6) Repack unused devices with anti-moisture packing, fold to close any opening and then store in a dry place.
- 7) Devices require baking before mounting, if humidity card reading is >60 % at 23 \pm 5 °C.
- 8) Devices must be baked for 1 hour at 60 ± 5 °C, if baking is required.
- 9) The LEDs are sensitive to the static electricity and surge current. It is recommended to use a wrist band or antielectrostatic glove when handling the LEDs. If voltage exceeding the absolute maximum rating is applied to LEDs, it may cause damage or even destruction to LED devices. Damaged LEDs may show some unusual characteristics such as increase in leakage current, lowered turn-on voltage, or abnormal lighting of LEDs at low current.
- 10) VOCs (Volatile Organic Compounds) can be generated from adhesives, flux, hardener or organic additives used in luminaires (fixtures). Transparent LED silicone encapsulant is permeable to those chemicals and they may lead to a discoloration of encapsulant when they exposed to heat or light. This phenomenon can cause a significant loss of light emitted (output) from the luminaires. In order to prevent these problems, we recommend users to know the physical properties of materials used in luminaires and they must be carefully selected.

Legal and additional information.

About Samsung Electronics Co., Ltd.

Samsung Electronics Co., Ltd. inspires the world and shapes the future with transformative ideas and technologies, redefining the worlds of TVs, smartphones, wearable devices, tablets, cameras, digital appliances, printers, medical equipment, network systems and semiconductors. We are also leading in the Internet of Things space through, among others, our Digital Health and Smart Home initiatives. We employ 307,000 people across 84 countries. To discover more, please visit our official website at www.samsung.com and our official blog at global.samsungtomorrow.com.

Samsung provides limited warranty for its LED products, the full text of which is available at https://www.samsung.com/led/support/warranties

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www.samsungled.com

